

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Harki Tanaka	05/18/2009
RECEIVING PARTY DATA	
Name:	Timpel S.A.
Street Address:	Av. Prof. Lineu Prestes, 2242
Internal Address:	Predioc Cietec, 2nd Floor, Room 03
City:	Butanta, Sao Paulo
State/Country:	BRAZIL
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12383604
CORRESPONDENCE DATA	
Fax Number:	(703)836-5288
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	703-684-5600
Email:	jpdeleon@sagllp.com
Correspondent Name:	Shlesinger, Arkwright & Garvey LLP
Address Line 1:	1420 King Street
Address Line 2:	Suite 600
Address Line 4:	Alexandria, VIRGINIA 22314
ATTORNEY DOCKET NUMBER:	C7708
NAME OF SUBMITTER:	Josefino P de Leon
Total Attachments: 2 source=7708_12383604_Assignment#page1.tif source=7708_12383604_Assignment#page2.tif	

CH \$40.00 12383604

500869253

PATENT
REEL: 022736 FRAME: 0465

A S S I G N M E N T

WHEREAS, I, HARKI TANAKA, residing at Rua São Joaquim, 580, Apto. 25-2, Bairro da Liberdade CEP: 01508-000, São Paulo, Brazil, have invented new, and useful improvement for DATA COLLECTION FOR ELECTRICAL IMPEDANCE TOMOGRAPHY for which an application for Letters Patent of the United States was filed on March 27, 2009 and accorded Serial No. 12/383,604; and

WHEREAS, TIMPEL S.A., having a place of business at Av. Prof. Lineu Prestes, 2242, prédio Cietec, 2nd floor, Room 03, Butantã, São Paulo, Brazil, is desirous of acquiring the entire right, title and interest in and to said invention and said application for Letters patent and in and to any Letters Patent that may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me in hand paid, the receipt of which is hereby acknowledged, and for other good and valuable consideration, I, Harki Tanaka, hereby assigns, sells and transfers unto said TIMPEL S.A., the full and exclusive right to said invention in the United States and its territorial possessions and in any and all foreign countries, and said application for Letters Patent and any and all inventions disclosed therein and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and

in any and all foreign countries, and in and to any and all divisions, reissues, continuations and extensions thereof.

I hereby authorize and request the Patent Office officials in the United States and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said TIMPEL S.A. as the assignee of my entire right, title and interest in and to the same, for the sole use and benefit of TIMPEL S.A., its successors and assigns.

Further, I agree that I will communicate to said TIMPEL S.A. or its representatives any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuations, substitutions, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to TIMPEL S.A., make all rightful oaths and generally to do everything possible to aid said TIMPEL S.A., its successors and assigns, to obtain and enforce protection for said invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, I have hereunto set my hands this

18th day of May, 2009.


HARKI TANAKA